

## Electronic Acknowledgement Receipt

<b>EFS ID:</b>	6905616
<b>Application Number:</b>	10786876
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	1903
<b>Title of Invention:</b>	Coating for reducing contamination of substrates during processing
<b>First Named Inventor/Applicant Name:</b>	Vijay D. Parkhe
<b>Customer Number:</b>	61285
<b>Filer:</b>	Ashokkumar Janah/Steven Metz
<b>Filer Authorized By:</b>	Ashokkumar Janah
<b>Attorney Docket Number:</b>	008850 USA/CPI/COPPER/PJS
<b>Receipt Date:</b>	28-JAN-2010
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<b>Application Type:</b>	Utility under 35 USC 111(a)

### Payment information:

Submitted with Payment	no
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### File Listing:

Document Number	Document Description	File Name	File Size(Bytes)/ Message Digest	Multi Part /.zip	Pages (if appl.)
1		8850_S-IDS_Transmittals_1-28-10.pdf	140579 1725aa1a11cb3ec9e9feb47de07137e3248cc976	yes	6

	Multipart Description/PDF files in .zip description				
	Document Description		Start	End	
	Miscellaneous Incoming Letter		1	2	
	Transmittal Letter		3	6	
Warnings:					
Information:					
2	Information Disclosure Statement (IDS) Filed (SB/08)	8850_S-IDS_1-28-10.pdf	52180 926743f71f9370c47323ae62ca7c9d4431d9a115	no	3
Warnings:					
Information:					
This is not an USPTO supplied IDS fillable form					
3	NPL Documents	XIAO_Intro_to_Semiconductor _mfg_tech.pdf	304542 78a562b9e84893fc4be3664005f189320a6f04fb	no	3
Warnings:					
Information:					
4	Foreign Reference	EP0322812.pdf	1253294 25aef84a1b60dbafc741ad4747e8bf4bdd5194c	no	15
Warnings:					
Information:					
5	Foreign Reference	JP10217103A.pdf	356814 37234ba5222952c5c2f67bc1fb52ba5e63ee85e7	no	7
Warnings:					
Information:					
6	Foreign Reference	WO2004010484.pdf	1122921 4a6f5307304dfe0efcaf34154b060e4399ea23bd	no	30
Warnings:					
Information:					
7	Foreign Reference	WO2005087974.pdf	2343687 5a76628a3421a3630208463da8432a6ea7705d46	no	51
Warnings:					
Information:					
8	Foreign Reference	WO2004001799.pdf	1206996 51307c0c68f7933f6e3c2475066d8b1053ef6796	no	34
Warnings:					

<b>Information:</b>					
9	Foreign Reference	WO9845090.pdf	3385678 e00ac42c65c74505176d793e29f2e2bd9b6f eebc	no	81
<b>Warnings:</b>					
<b>Information:</b>					
10	Fee Worksheet (PTO-875)	fee-info.pdf	30275 bf3dc8526f0e73f2b61438dde7c5e61ccf30f 350	no	2
<b>Warnings:</b>					
<b>Information:</b>					
<b>Total Files Size (in bytes):</b>			10196966		
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